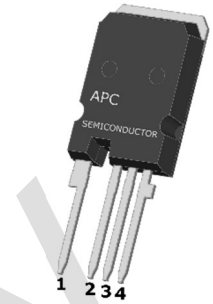
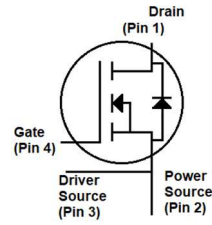




# SiC Power MOSFET with Ceramic Isolated Baseplate Tab

## AMR075V120H2i



### Applications:

- Solar Inverters
- Uninterrupted power supplies
- Switch mode power supplies
- Motor drives

### Features:

- High blocking voltage with low on-resistance
- High switching speed with low capacitance
- Very low switching losses
- Excellent avalanche ruggedness
- Very fast and robust intrinsic body diode with low reverse recovery
- 0V turn-off  $V_{gs}$  for gate driving ease
- RoHS compliant

### Absolute Maximum Ratings ( $T_{amb}=25^{\circ}C$ , unless specified otherwise)

Symbol	Parameter	Value	Unit
$V_{DS}$	DC Reverse Voltage	1200	V
$V_{GSmax}$	Gate-source voltage, max. transient voltage	-11/+25	
$V_{GSmax}$	Gate-source voltage, max. static voltage	-10/+22	
$V_{GSop}$	Gate-source voltage	-5/+18	
$I_D$	Continuous drain current ( $V_{GS} = 18V$ )	27	A
	Continuous drain current ( $V_{GS} = 18V$ ), $T_C = 100^{\circ}C$	19	
$I_{D(pulse)}$	Pulsed drain current (Pulse width limited by $T_{jmax}$ )	68	A
$P_{tot}$	Power dissipation	160	W
$T_j$	Operating junction temperature	-55 to 175	$^{\circ}C$
$T_{stg}$	Storage temperature	-55 to 175	$^{\circ}C$

### Thermal and Mechanical Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
$R_{\theta JC}$	Junction-to-case thermal Resistance	-	TBD	-	$^{\circ}C/W$

**Static Electrical Characteristics ( $T_A = 25^\circ\text{C}$ , unless specified otherwise)**

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 100\mu A$	1200	-	-	
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS} = V_{GS}, I_D = 2.5mA^a$	1.8	2.9	4.2	V
		$V_{DS} = V_{GS}, I_D = 2.5mA,$ $T_J = 175^\circ\text{C}^a$	-	2.2	-	
$I_{DSS}$	Drain-Source Leakage current	$V_{DS} = 1200V, V_{GS} = 0V$	-	1	150	$\mu A$
$I_{GSS}$	Gate-Source leakage current	$-11V < V_{GS} < 25V$	-	1	100	nA
$R_{DS(on)}$	Drain-Source ON Resistance	$V_{GS} = 15V, I_D = 18A$	-	97	-	m $\Omega$
		$V_{GS} = 18V, I_D = 18A$	-	75	98	
		$V_{GS} = 18V, I_D = 18A,$ $T_J = 175^\circ\text{C}$	-	140	-	
$g_{fs}$	Transconductance	$V_{DS} = 20V, I_D = 18A$	-	11	-	S
		$V_{DS} = 20V, I_D = 18A,$ $T_J = 175^\circ\text{C}$	-	10	-	
$R_{g(int)}$	Internal gate resistance	$f = 1MHz, V_{AC} = 25mV$	-	4.8	-	$\Omega$

<sup>a</sup> Pre-condition  $V_{th}$ , as per JEDEC standard JEP183A, (Revision of JEP183 January 2021)

**Dynamic Characteristics ( $T_A = 25^\circ\text{C}$ , unless specified otherwise)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0V, V_{DS} = 1000V,$ $f = 100kHz, V_{AC} = 25mV$	-	815	-	pF
$C_{oss}$	Output Capacitance		-	38	-	
$C_{rss}$	Reverse Transfer Capacitance		-	3	-	
$E_{oss}$	$C_{oss}$ stored energy		-	22	-	$\mu J$
$Q_{gs}$	Gate-Source Gate Charge	$V_{DD} = 800V, V_{GS} = -5/+18V,$ $I_D = 18A, I_{GS} = 1mA$	-	12	-	nC
$Q_{gd}$	Gate-Drain Gate Charge		-	14	-	
$Q_g$	Total Gate Charge		-	40	-	

**Switching Characteristics ( $T_A = 25\text{ }^\circ\text{C}$ , unless specified otherwise)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit	
$T_{d(on)}$	Turn-on delay time	$V_{DD} = 800V$ , $V_{GS} = -5/+18V^b$ , $I_D = 18A$ , $R_{G(ext)} = 2.4\Omega$ , $L = 110\mu H$	-	6	-	ns	
$T_r$	Rise time		-	12	-		
$T_{d(off)}$	Turn-off delay time		-	17	-		
$T_f$	Fall time		-	8	-		
$E_{on}$	Turn On Switching Energy		$V_{DD} = 800V$ , $V_{GS} = -5/+18V^b$ , $I_D = 18A$ , $R_{G(ext)} = 2.4\Omega$ , $L = 110\mu H$ , $T_j = 175^\circ\text{C}$	-	178	-	$\mu J$
$E_{off}$	Turn Off Switching Energy			-	15	-	
$T_{d(on)}$	Turn-on delay time	$V_{DD} = 800V$ , $V_{GS} = -5/+18V^b$ , $I_D = 18A$ , $R_{G(ext)} = 2.4\Omega$ , $L = 110\mu H$ , $T_j = 175^\circ\text{C}$		-	5	-	ns
$T_r$	Rise time			-	14	-	
$T_{d(off)}$	Turn-off delay time			-	19	-	
$T_f$	Fall time			-	8	-	
$E_{on}$	Turn On Switching Energy		$T_j = 175^\circ\text{C}$	-	267	-	$\mu J$
$E_{off}$	Turn Off Switching Energy			-	18	-	

<sup>b</sup> This SIC MOSFET can switch with driver pulses 0V to 20V with optimized PCB layouts and gate drive circuits.

**Body Diode Characteristics ( $T_A = 25\text{ }^\circ\text{C}$ , unless specified otherwise)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$V_{SD}$	Body Diode Forward Voltage	$V_{GS} = -5V$ , $I_{SD} = 18A$	-	4.8	-	V
		$V_{GS} = -5V$ , $I_{SD} = 18A$ , $T_j = 175^\circ\text{C}$	-	4.2	-	
$I_S$	Continuous diode forward current	$V_{GS} = -5V$ , $T_C = 25^\circ\text{C}$	-	-	27	A
$I_{S, pulse}$	Diode Pulse Current	$V_{GS} = -5V$ , pulse width $t_p$ limited by $T_{jmax}$	-	-	68	A
$t_{rr}$	Reverse recovery time	$V_{GS} = -5V$ , $I_{SD} = 18A$ , $V_R = 800V$ , $di_t/dt = 3.01kA/\mu s$	-	8	-	ns
$Q_{rr}$	Reverse recovery charge		-	0.12	-	$\mu C$
$I_{rrm}$	Peak reverse recovery current	$V_{GS} = -5V$ , $I_{SD} = 18A$ , $V_R = 800V$ , $T_j = 175^\circ\text{C}$ , $di_t/dt = 2.97kA/\mu s$	-	26	-	A
$t_{rr}$	Reverse recovery time		-	14	-	ns
$Q_{rr}$	Reverse recovery charge		-	0.37	-	$\mu C$
$I_{rrm}$	Peak reverse recovery current		-	46	-	A

### Electrical Characteristic Diagrams

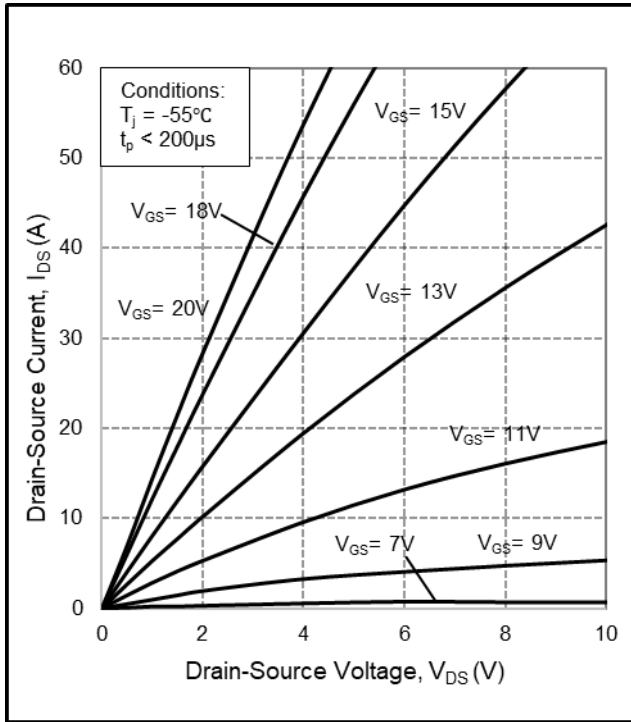


Figure 1. Output characteristics at  $T_j = -55^\circ\text{C}$

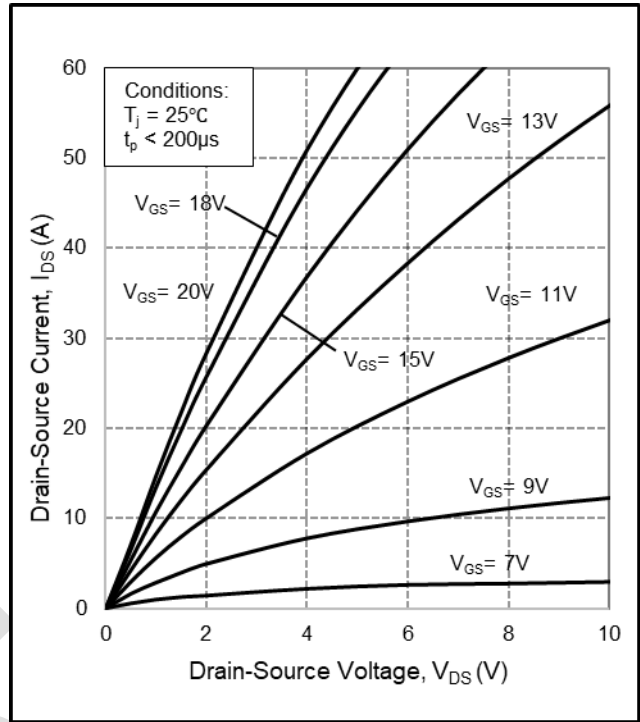


Figure 2. Output characteristics at  $T_j = 25^\circ\text{C}$

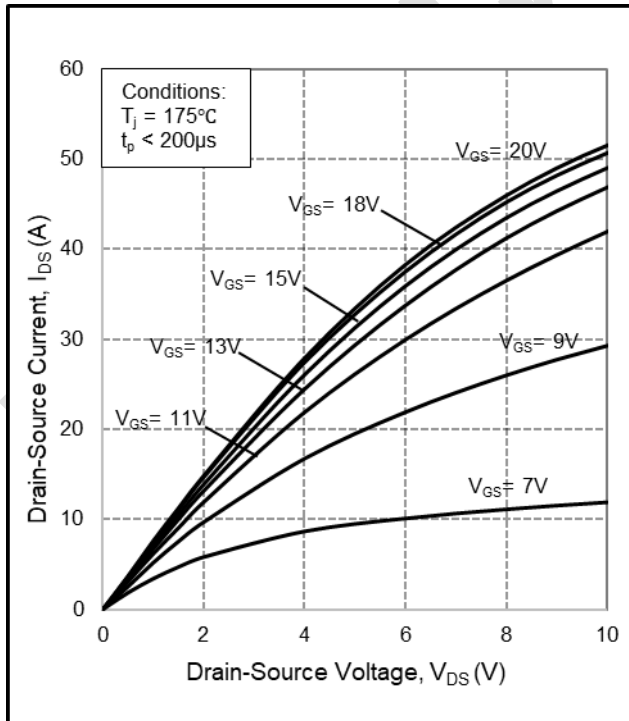


Figure 3. Output characteristics at  $T_j = 175^\circ\text{C}$

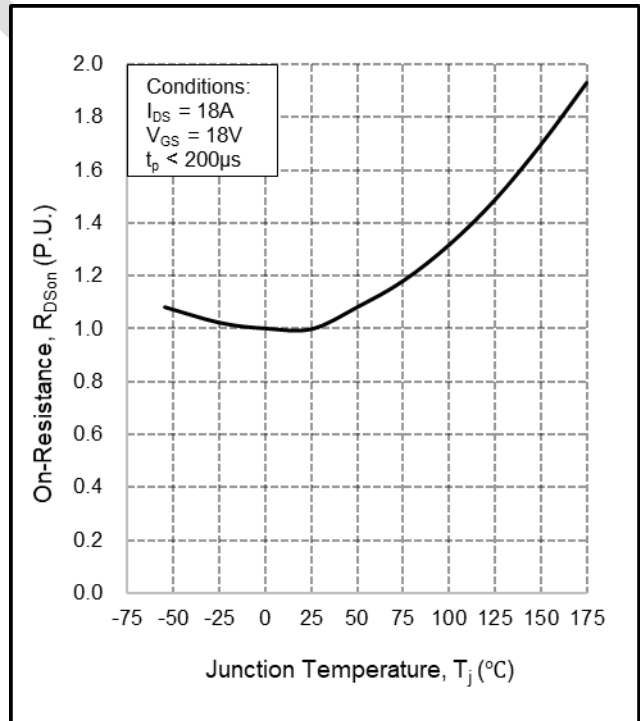


Figure 4. Normalized on-resistance vs. temperature

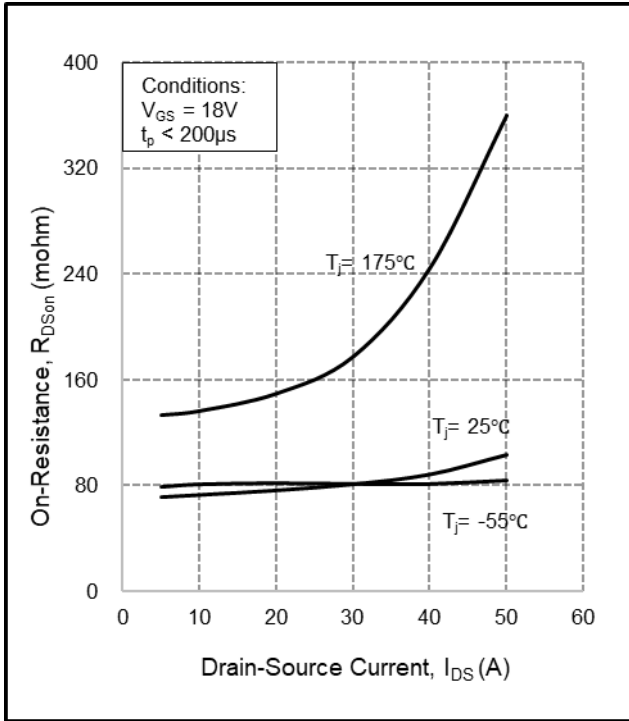


Figure 5. On-resistance vs. drain current for various temperatures

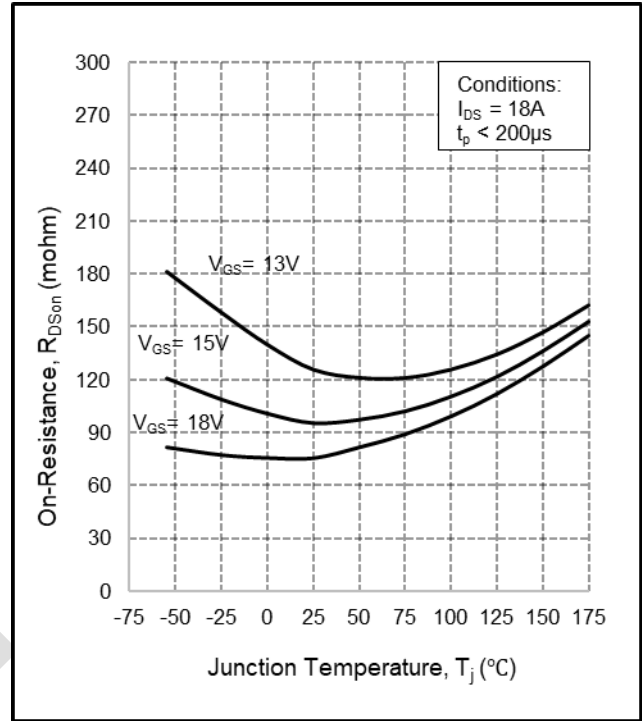


Figure 6. On-resistance vs. temperature for various gate voltages

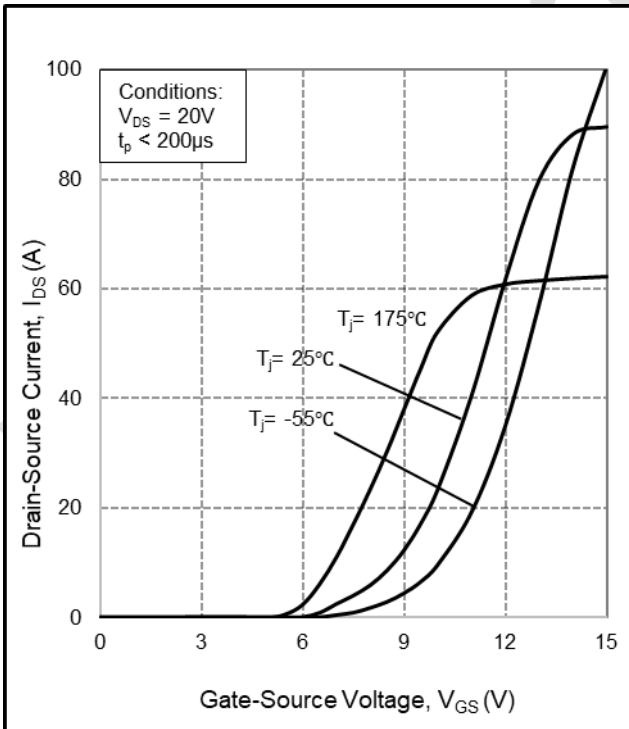


Figure 7. Transfer characteristic for various junction temperatures

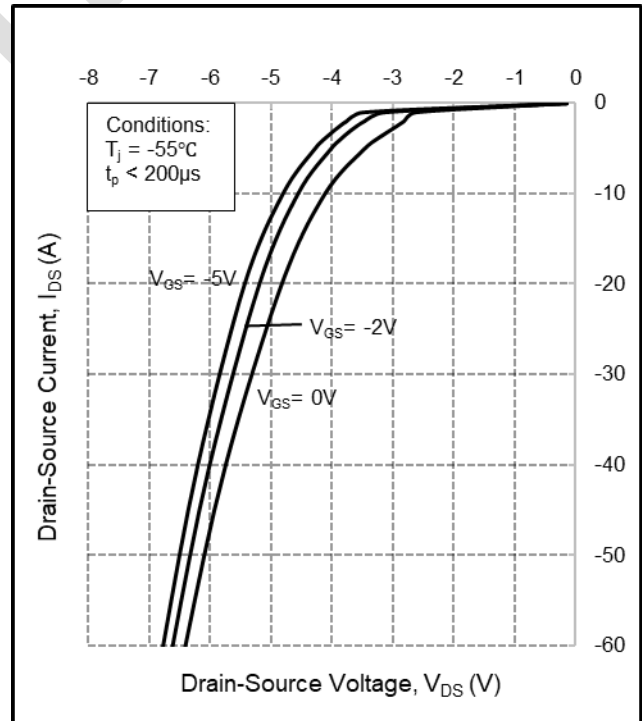


Figure 8. Body diode characteristic at  $T_j = -55^\circ\text{C}$

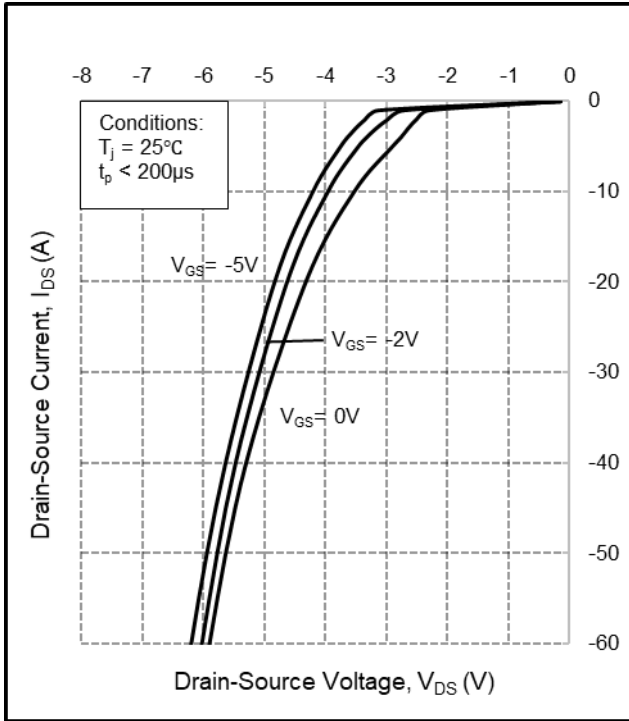


Figure 9. Body diode characteristic at  $T_j = 25^\circ\text{C}$

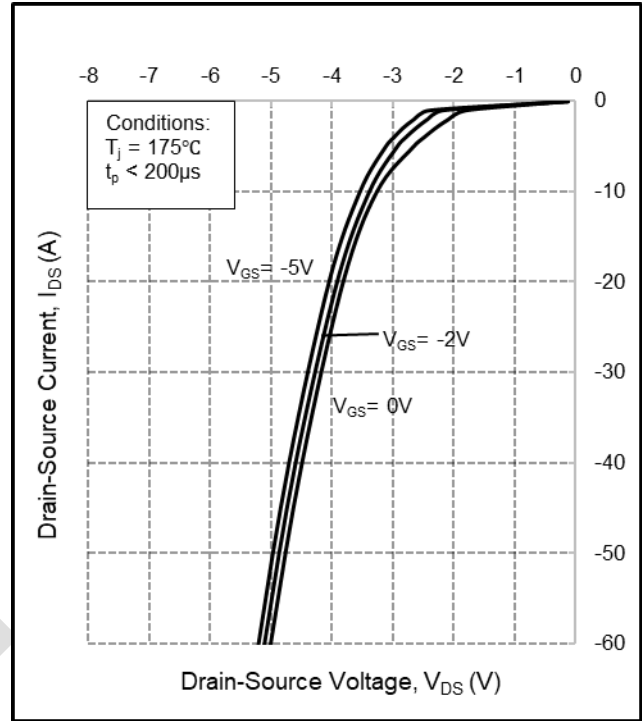


Figure 10. Body diode characteristic at  $T_j = 175^\circ\text{C}$

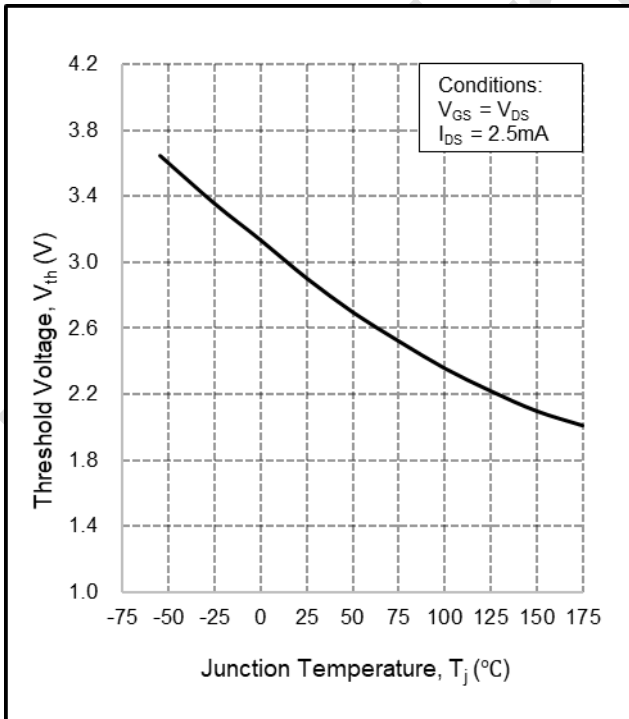


Figure 11. Threshold voltage vs. temperature

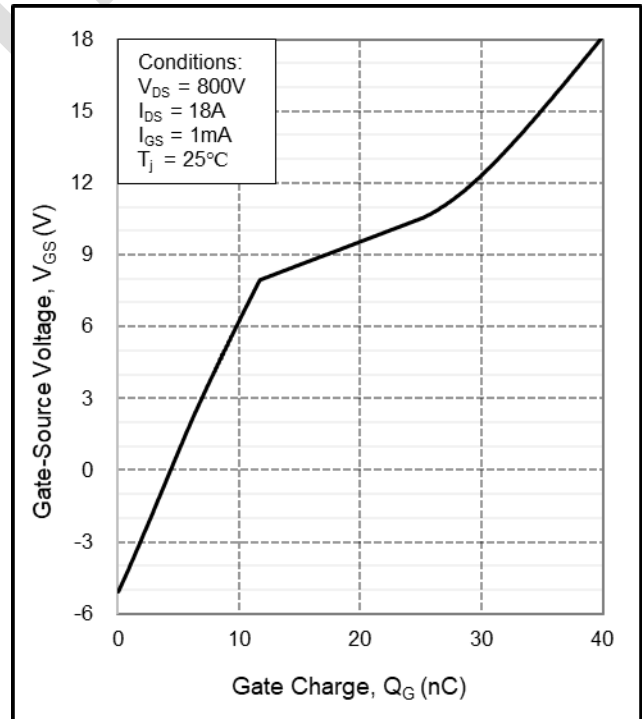


Figure 12. Gate charge characteristics

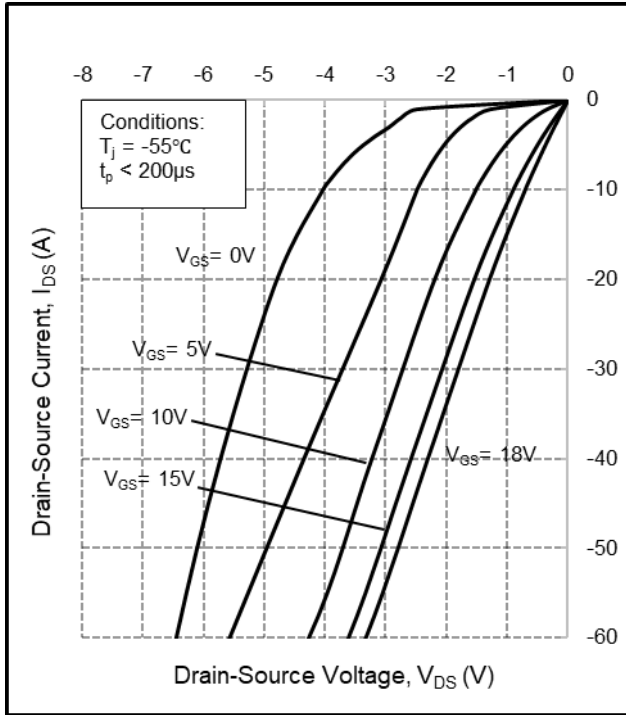


Figure 13. 3rd quadrant characteristic at  $T_j = -55^\circ\text{C}$

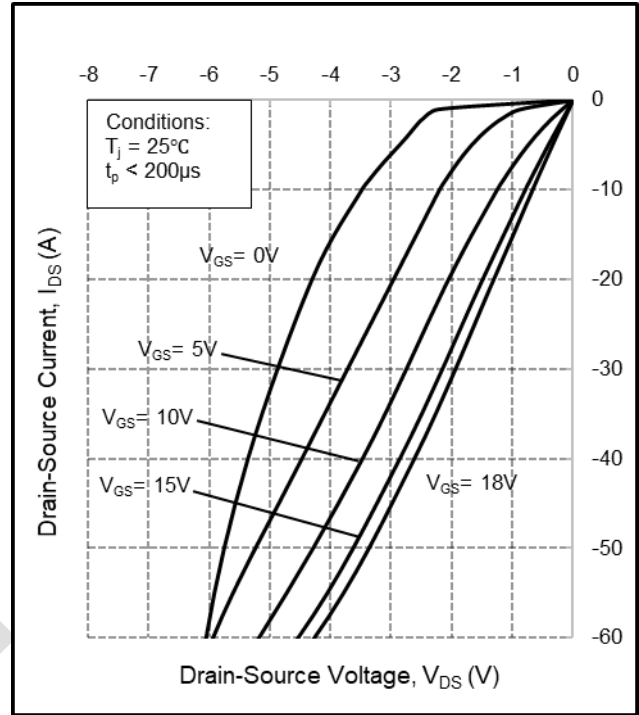


Figure 14. 3rd quadrant characteristic at  $T_j = 25^\circ\text{C}$

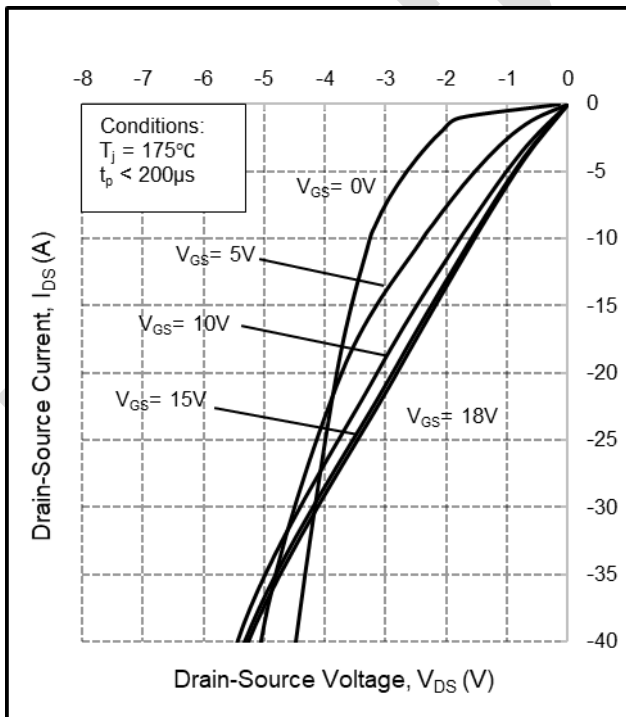


Figure 15. 3rd quadrant characteristic at  $T_j = 175^\circ\text{C}$

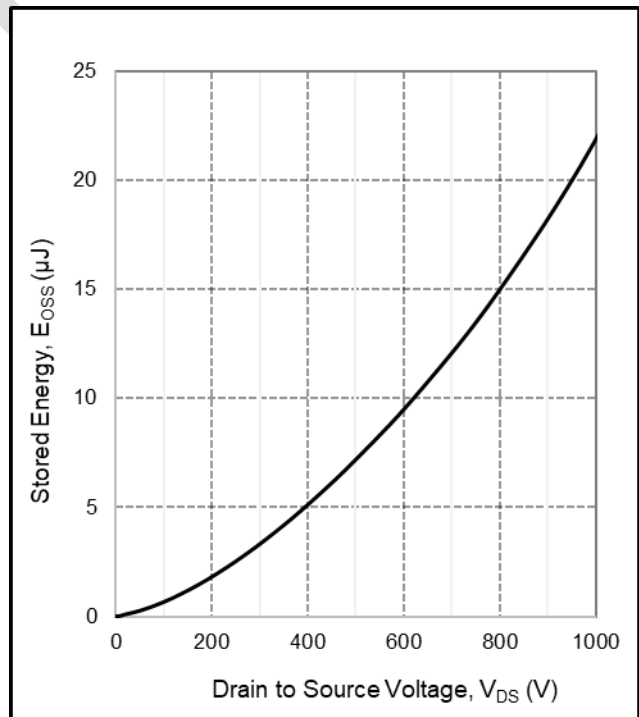


Figure 16. Output capacitor stored energy

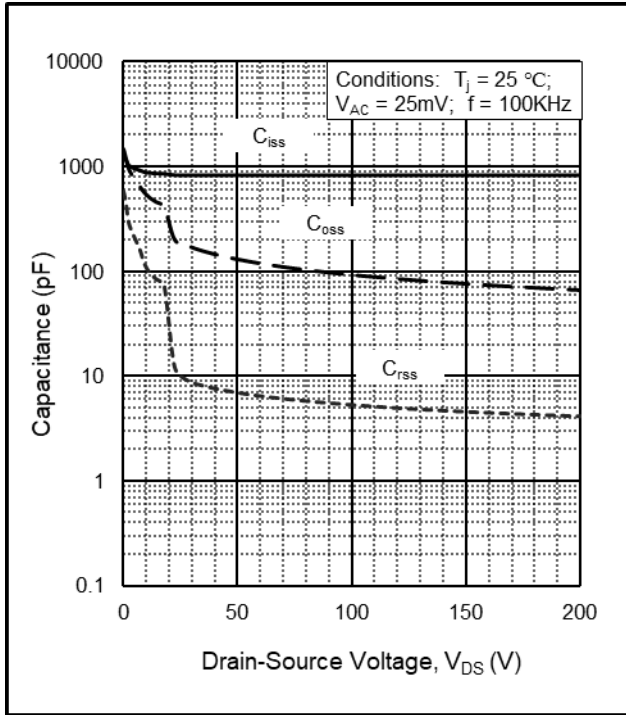


Figure 17. Capacitance vs. drain-source voltage (0 - 200V)

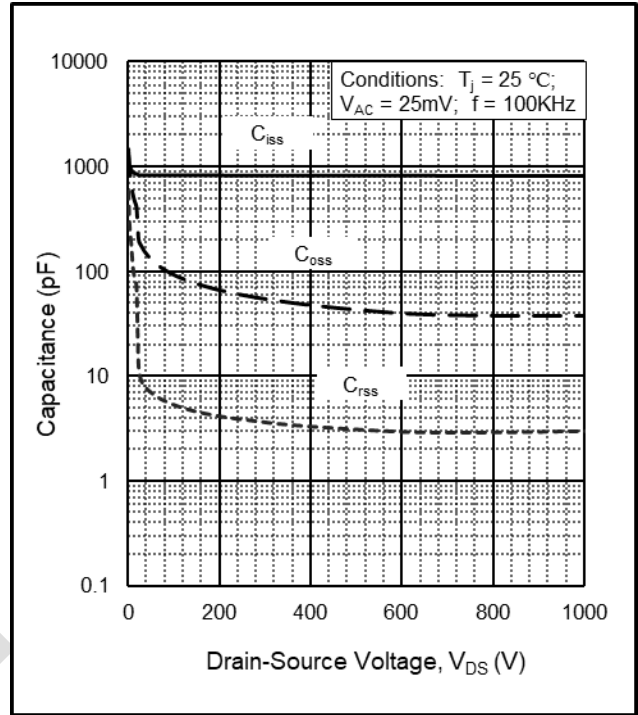


Figure 18. Capacitance vs. drain-source voltage (0 - 1000V)

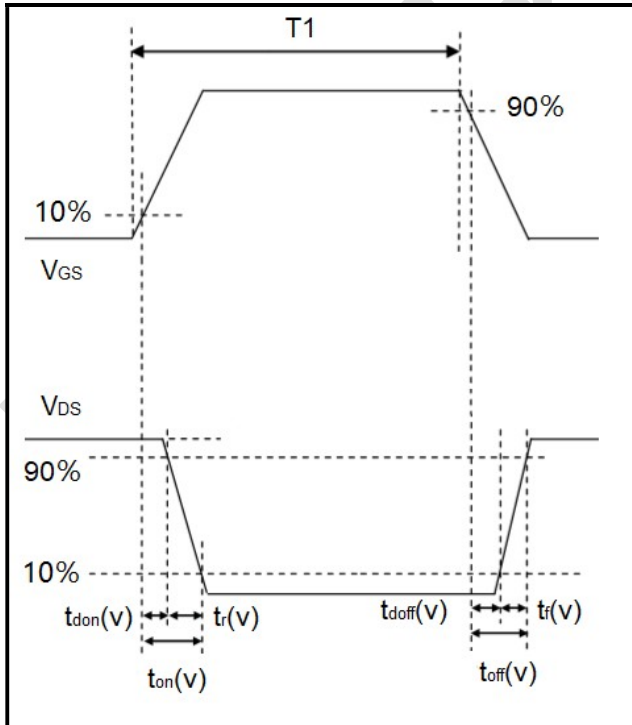


Figure 19. Switching times definition

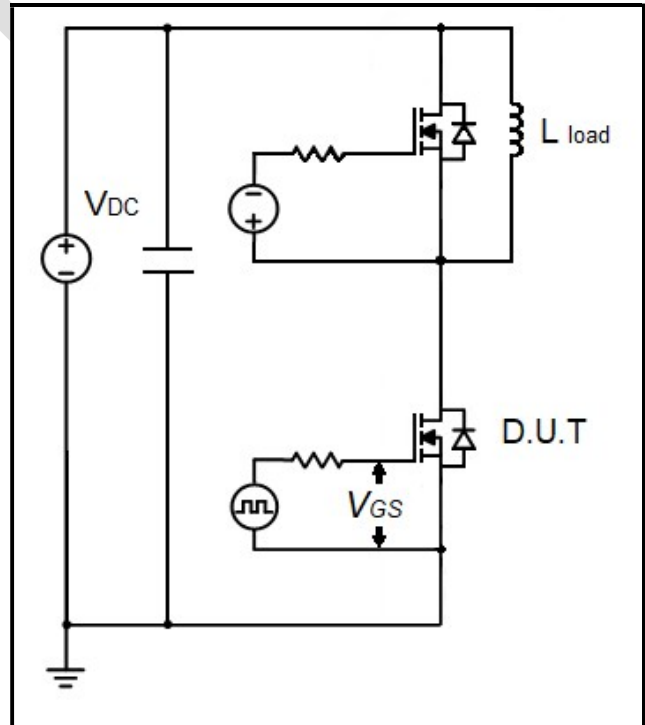


Figure 20. Clamped inductive switching waveform test circuit

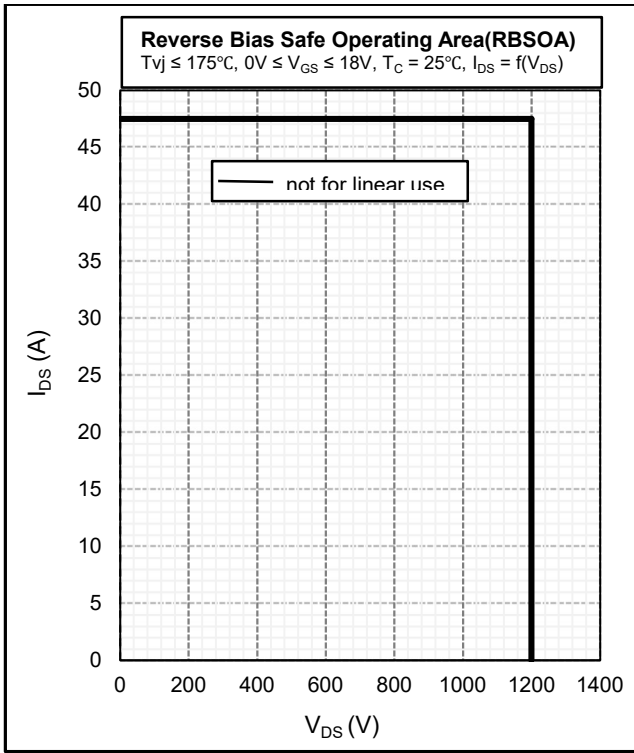
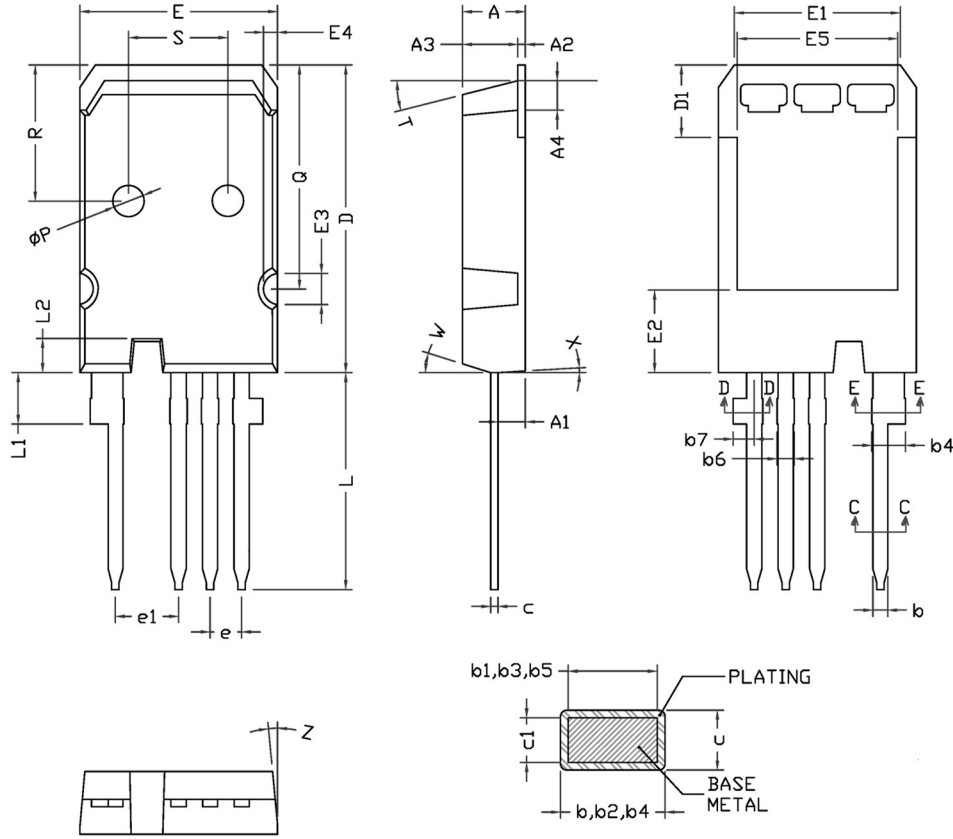


Figure 21. Reverse Bias Safe Operating Area

**Package Information:**



SECTION C-C, D-D, E-E

AREA	MIN	NOM	MAX
A	4,84	5.03	5.22
A1	2.29	2.39	2.49
A2	0.65	0.70	0.78
A3	4.20	4.33	4.46
A4	2.07	2.20	2.33
D	24,60	24,75	24,85
D1	5,68	5,83	5,98
E	15,71	15,90	16.09
E1	13.22	13.35	13.48
E2	5,93	6,63	7.33
E3	1.82	2.53	3.24
E4	0,81	1.04	1.24
E5	12.37	12,90	13.43
e	2.54 BSC		
e1	5.08 BSC		
L	17.27	17,52	17,77
L1	3,97	4.17	4.37
L2	2.35	2.50	2.65

AREA	MIN	NOM	MAX
b	1.07	-	1.33
b1	1.07	1.20	1.28
b2	2.39	-	2,64
b3	2.39	-	2.69
b4	2.39	-	2,94
b5	2.39	2.53	2.84
b6	1.07	-	1.60
b7	1.30	-	1.70
c	0.65	-	0.78
c1	0,65	0.70	0.75
ϕP	2.40	2.50	2.70
Q	17,77	18.02	18.27
R	10,78	10,98	11.18
S	7,80	8.00	8.20
T	14° REF		
W	21° REF		
X	3° REF		
Z	5° REF		

**Ordering Information**

Part number	AMR075V120H2i
Package	TO-247-4L (Isolated)
Unit quantity	300 EA
Packing type	Tube

For more information, visit <https://www.apowerc2.com>

Preliminary